



מגש L2 מעבד 2.2 ג'יגה הרץ 1 מגה בייט HP AMD Athlon 64 X2 4200+

מונתג : HP

קוד מוצר : EG832AV

שם דגם : AMD Athlon 64 X2 4200+



סוג אריזה: מגש, מח תהליך הייצור של המעבד: 65 ננומטר, AM2, מעבד, שקע: שקע. HP AMD Athlon 64 X2 4200+.
מגה בייט L1 cache: 0.25

מעבד		מעבד	
* מעבד, מודל	4200+	TDP ערך	65 W
* תדר בסיס של מעבד	2.2 ג'יגה הרץ	* סוג אריזה	מגש
* מעבד מספר ליבות	2	VID טווח מתח	1.25 - 1.3 V
* מעבד, שקע	שקע AM2	מדרגות	G1
* תהליך הייצור של המעבד	מח 65 ננומטר	תנאי הסביבה	
* מצבי העבודה של המעבד	64-bit	טמפרטורת פעולה מקסימלית	72 °C
זיכרון המטמון של המעבד	מגה בייט 1	פיצ'רים נוספים	
סוג זיכרון המטמון של המעבד	L2	L1 cache	מגה בייט 0.25

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